

**STPS10L60D**

POWER SCHOTTKY RECTIFIER

MAIN PRODUCT CHARACTERISTICS

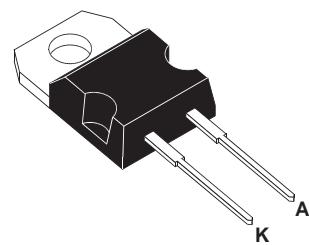
| | |
|----------------------|--------|
| I _{F(AV)} | 10 A |
| V _{RRM} | 60 V |
| T _j (max) | 150°C |
| V _F (max) | 0.56 V |

FEATURES AND BENEFITS

- LOW FORWARD VOLTAGE DROP
- NEGLIGIBLE SWITCHING LOSSES
- LOW THERMAL RESISTANCE

DESCRIPTION

Schottky rectifier suited for Switched Mode Power Supplies and high frequency DC to DC converters. Packaged in TO220-AC, this device is intended for use in DC/DC chargers.



TO220-AC

ABSOLUTE RATINGS (limiting values)

| Symbol | Parameter | Value | Unit |
|---------------------|--|---------------|------|
| V _{RRM} | Repetitive peak reverse voltage | 60 | V |
| I _{F(RMS)} | RMS forward current | 30 | A |
| I _{F(AV)} | Average forward current | 10 | A |
| I _{FSM} | Surge non repetitive forward current | 220 | A |
| I _{IRRM} | Repetitive peak reverse current | 1 | A |
| T _{stg} | Storage temperature range | - 65 to + 175 | °C |
| T _j | Maximum operating junction temperature * | 150 | °C |
| dV/dt | Critical rate of rise of reverse voltage | 10000 | V/μs |

* : $\frac{dP_{tot}}{dT_j} < \frac{1}{R_{th}(j-a)}$ thermal runaway condition for a diode on its own heatsink

STPS10L60D

THERMAL RESISTANCES

| Symbol | Parameter | Value | Unit |
|----------------------|------------------|-------|------|
| R _{th(j-c)} | Junction to case | 1.6 | °C/W |

STATIC ELECTRICAL CHARACTERISTICS

| Symbol | Parameter | Tests conditions | | Min. | Typ. | Max. | Unit |
|------------------|-------------------------|------------------------|-----------------------------------|------|------|------|------|
| I _R * | Reverse leakage current | T _j = 25°C | V _R = V _{RRM} | | | 350 | µA |
| | | T _j = 125°C | | | 65 | 95 | mA |
| V _F * | Forward voltage drop | T _j = 25°C | I _F = 10 A | | | 0.6 | V |
| | | T _j = 125°C | I _F = 10 A | | 0.48 | 0.56 | |
| | | T _j = 25°C | I _F = 20 A | | | 0.74 | |
| | | T _j = 125°C | I _F = 20 A | | 0.62 | 0.7 | |

Pulse test : * tp = 380 µs, δ < 2%

To evaluate the conduction losses use the following equation :

$$P = 0.42 \times I_{F(AV)} + 0.014 I_{F}^2(RMS)$$

Fig. 1: Average forward power dissipation versus average forward current.

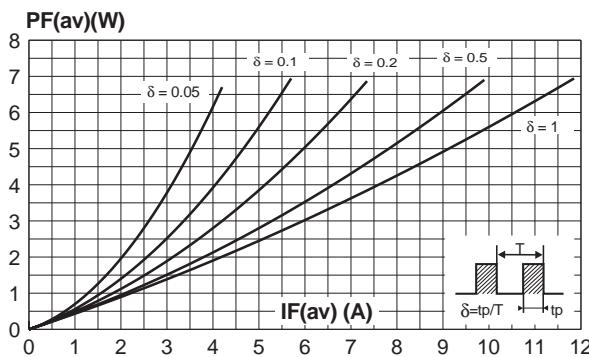


Fig. 2: Average forward current versus ambient temperature(δ = 0.5).

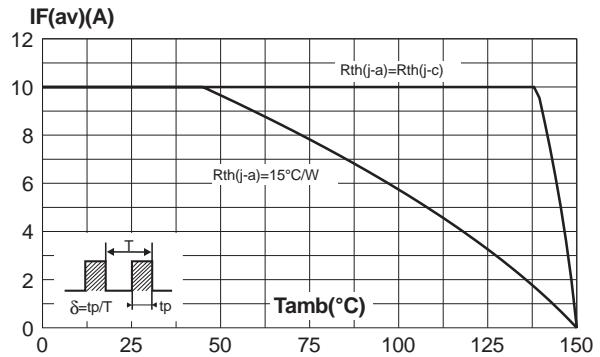


Fig. 3: Non repetitive surge peak forward current versus overload duration (maximum values).

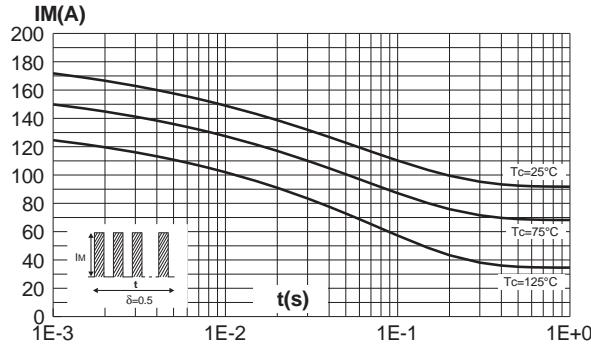


Fig. 4: Relative variation of thermal impedance junction to lead versus pulse duration.

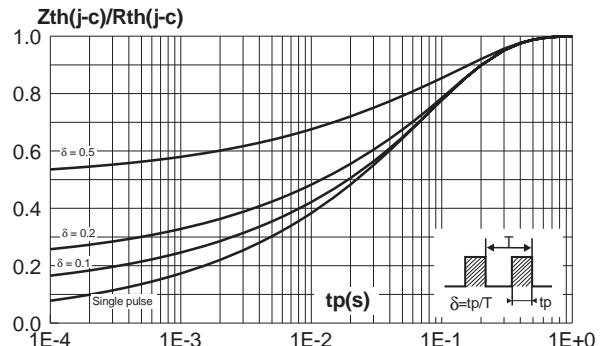


Fig. 5: Reverse leakage current versus reverse voltage applied (typical values).

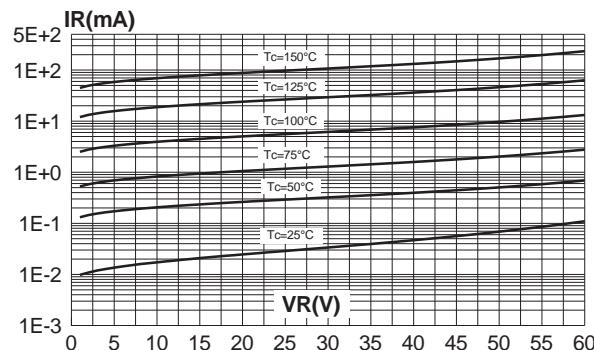


Fig. 6: Junction capacitance versus reverse voltage applied (typical values).

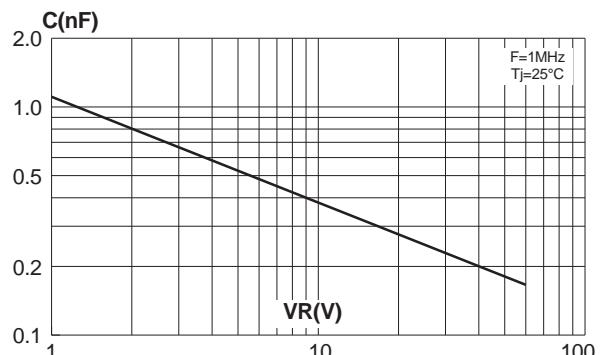
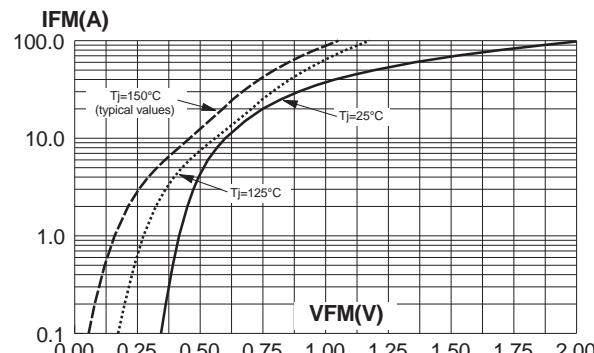
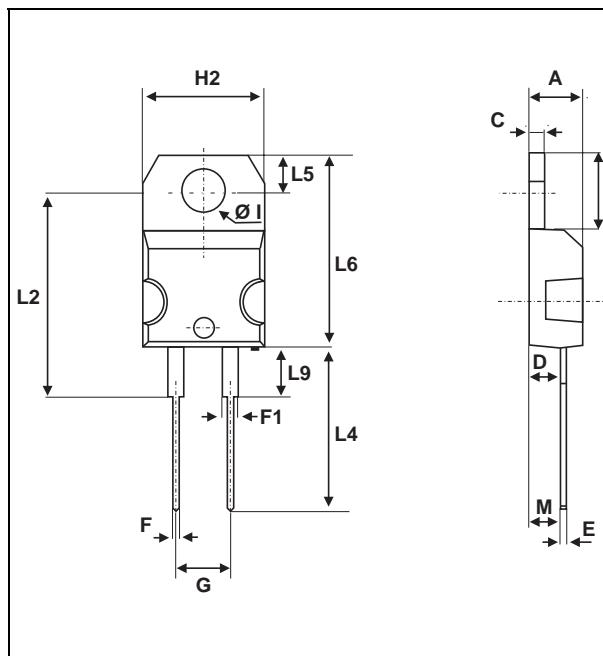


Fig. 7: Forward voltage drop versus forward current (low level, maximum values).



STPS10L60D

PACKAGE MECHANICAL DATA TO220-AC



| REF. | DIMENSIONS | | | |
|---------|-------------|-------|------------|-------|
| | Millimeters | | Inches | |
| | Min. | Max. | Min. | Max. |
| A | 4.40 | 4.60 | 0.173 | 0.181 |
| C | 1.23 | 1.32 | 0.048 | 0.051 |
| D | 2.40 | 2.72 | 0.094 | 0.107 |
| E | 0.49 | 0.70 | 0.019 | 0.027 |
| F | 0.61 | 0.88 | 0.024 | 0.034 |
| F1 | 1.14 | 1.70 | 0.044 | 0.066 |
| G | 4.95 | 5.15 | 0.194 | 0.202 |
| H2 | 10.00 | 10.40 | 0.393 | 0.409 |
| L2 | 16.40 typ. | | 0.645 typ. | |
| L4 | 13.00 | 14.00 | 0.511 | 0.551 |
| L5 | 2.65 | 2.95 | 0.104 | 0.116 |
| L6 | 15.25 | 15.75 | 0.600 | 0.620 |
| L7 | 6.20 | 6.60 | 0.244 | 0.259 |
| L9 | 3.50 | 3.93 | 0.137 | 0.154 |
| M | 2.6 typ. | | 0.102 typ. | |
| Diam. I | 3.75 | 3.85 | 0.147 | 0.151 |

- Cooling method : C
- Recommended torque value : 0.8m.N
- Maximum torque value : 1.0m.N

| Ordering type | Marking | Package | Weight | Base qty | Delivery mode |
|---------------|------------|----------|--------|----------|---------------|
| STPS10L60D | STPS10L60D | TO220-AC | 1.86g | 50 | Tube |
| STPS10L60D | STPS10L60D | TO220-AC | 1.86g | 1000 | Bulk |

- Epoxy meets UL94,V0

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